

#### **Features**

- Fast Switching Speed
- ◆ For General Purpose Switching Applications
- ♦ High Conductance



### Absolute Maximum Ratings (TA=25 °C)

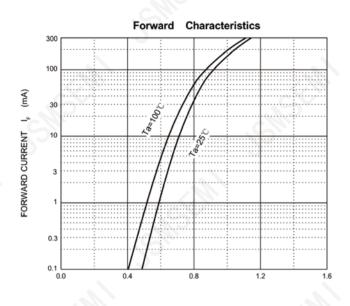
Symbol	Parameter	Value	Uniat	
V <sub>RM</sub>	Non-Repetitive Peak Reverse Voltage	100	V	
Vrrm	Peak Repetitive Peak Reverse Voltage			
VRWM	Working Peak Reverse Voltage	erse Voltage 75		
VR	DC Blocking Voltage		9	
VR(RMS)	RMS Reverse Voltage	53	V	
Iғм	Forward Continuous Current	300	mA	
lo	Average Rectified Output Current	150	mA	
IFSM	Non-repetitive Peak Forward Surge Current @ t= 8.3ms	2.0	Α	
Pd	Power Dissipation	225	mW	
Roja	Thermal Resistance From Junction To Ambient	556	°C/W	
$T_{J}$ , $T_{stg}$	Operation Junction and Storage Temperature Range	-55~+150	°C	

### Electrical Characteristics (TA=25° unless otherwise specified)

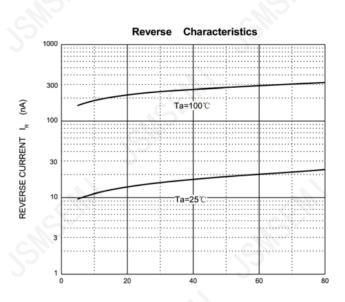
Symbol	Parameter	Test conditions		Тур	Max	Unit	
V(BR)	Reverse breakdown voltage	Ir=100μA	75			V	
<b>I</b> R	Reverse voltage leakage current	V <sub>R</sub> =75V			1	μA	
VF	Forward voltage	I⊧=1mA	12.		0.715		
		I <sub>F</sub> =10mA			0.855		
		I <sub>F</sub> =50mA			1		
		I <sub>F</sub> =150mA			1.25		
CD	Diode capacitance	V <sub>R</sub> =0V, f=1MHz		2	pF		
trr	Reverse recovery time	I <sub>F</sub> =I <sub>R</sub> =10mA,I <sub>rr</sub> =0.1×IR,R <sub>L</sub> =100Ω		6	nS		



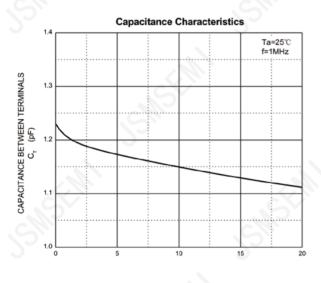
## **Typical Characteristics**



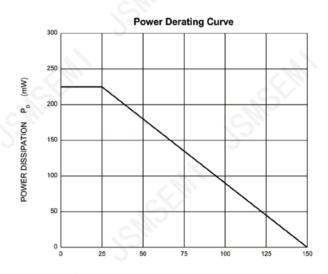
FORWARD VOLTAGEV V<sub>F</sub>(V)



REVERSE VOLTAGE VR(V)



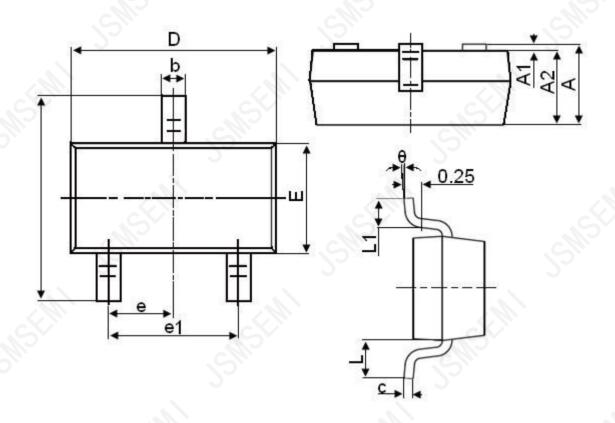
REVERSE VOLTAGE VR(V)



AMBIENTTEMPERATURE Ta(℃)



# **Package Outline Dimensions**



C/III-	Dimensions in Millimeters mm			
Symbol				
	Min		Max	
Α	0.900		1.150	
A1	0.000		0.100	
A2	0.900		1.050	
b	0.300		0.500	
С	0.080		0.150	
D	2.800	_1	3.000	
E	1.200		1.400	
E1	2.250	11/2	2.550	11/2
е		0.950TYP		(2)
e1	1.800	S	2.000	2
L		0.55	OREF	
L1	0.300		0.500	
θ	0°		8°	



#### **Revision History**

Rev.	Change	Date
V1.0	Initial version	2/23/2024

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